



信昌電子陶瓷股份有限公司  
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**Messrs. :** \_\_\_\_\_

**Date :** \_\_\_\_

# APPROVAL SHEET

**Product Name :** High-Voltage Multilayer Ceramic Chip Capacitors

**Part No. :** FV Series

**Description :** Size 0805~2225, C0G/X7R, 1000Vdc to 4000Vdc

PREPARED BY	APPROVED BY

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# SPECIFICATION

FOR

**Product Name** : High-Voltage Multilayer Ceramic Chip Capacitors  
**Part No.** : FV Series  
**Description** : Size 0805~2225, C0G/X7R, 1000Vdc to 4000Vdc

<b>SPEC. No.</b> : <u>FV-000-001-04</u>
<b>DATE</b> :

DRAWN BY	CHECEKED BY	APPROVED BY
<b>Yvens Chou</b>	<b>Yvens Chou</b>	<b>Ryan Chen</b>



# 1. INTRODUCTION

PDC FV Series green type capacitors are manufactured by using environmental friendly material without lead or cadmium. These capacitors feature series connection of multi-layer capacitor units in a MLCC to realize high voltage performance. This special design can distribute voltage gradients throughout the entire capacitor, so as to prevent short circuit failure. It is a safety design for LCD back-lighting inverter application.

## 2. FEATURES

- a. Special interior design offers high voltage rating in a given case size.
- b. High reliability and stability.
- c. RoHS compliant.

## 3. APPLICATIONS

- a. DC to DC converter.
- b. High voltage coupling/DC blocking.
- c. Back-lighting inverters.
- d. LAN/WLAN interface.
- e. Modem.
- f. Power supplies.

## 4. HOW TO ORDER

<b>FV</b>	<b>31</b>	<b>X</b>	<b>103</b>	<b>K</b>	<b>102</b>	<b>E</b>	<b>C</b>	<b>G</b>
PDC Family	Size	Dielectric	Capacitance	Tolerance	Rated voltage	Packaging	Thickness	Control Code
Table1.	Table2	Table3	Table4	Table5	Table6	Table7	Table8	Table9

Table 1		PDC family			
Code	Description				
FM	High voltage application with $\geq 1KVdc$				

Table 2		Size			
Code	Description	Code	Description	Code	Description
15	0402 (1005)	32	1210 (3225)	52	2211 (5728)
18	0603 (1608)	42	1808 (4520)	55	2220 (5750)
21	0805 (2012)	43	1812 (4532)	56	2225 (5763)
31	1206 (3216)	46	1825 (4563)		

Table 3				Dielectric Material Characteristics			
Code	Description	Code	Description	Code	Description	Code	Description
N	C0G	X	X7R				
B	X5R	F	Y5V				

Table 4				Table 4 Capacitance Rule Code			
Code	Description	Code	Description	Code	Description	Code	Description
R47	0.47pF	102	$102=10 \times 10^2=1000pF$				
0R5	0.5pF	104	$104=10 \times 10^4=100nF$				
100	$100=10 \times 10^0=10pF$	106	$106=10 \times 10^6=10\mu F$				

Table 5		Tolerance			
Code	Description	Code	Description	Code	Description
A	$\pm 0.05 pF$	I	-10% ~ 0%	Q	$\pm 0.03 pF$
B	$\pm 0.10 pF$	J	$\pm 5 \%$	Z	-20% ~ +80%
C	$\pm 0.25 pF$	K	$\pm 10 \%$		
D	$\pm 0.50 pF$	L	0% ~ +10%		
F	$\pm 1 \%$	M	$\pm 20 \%$		
G	$\pm 2 \%$	N	-5% ~ +10%		
H	$\pm 3 \%$	P	$\pm 0.02 pF$		

Table 6		Rated voltage			
Code	Description	Code	Description	Code	Description
6R3	6.3VDC	201	200VDC	152	1500VDC
100	10VDC	251	250VDC	202	2000VDC
160	16VDC	401	400VDC	302	3000VDC
250	25VDC	501	500VDC	402	4000VDC
500	50VDC	631	630VDC	502	5000VDC
101	100VDC	102	1000VDC	602	6000VDC

Table 7		Packaging Type			
Code	Description	Code	Description	Code	Description
B	Bulk	T	Tray package		
E	Tape and 7" Reel, Embossed Tape	P	Tape and 7" Reel, Paper Tape		
K	Tape and 10" Reel, Embossed Tape	D	Tape and 10" Reel, Paper Tape		
L	Tape and 13" Reel, Embossed Tape	G	Tape and 13" Reel, Paper Tape		

Table 8		Thickness Description			
Code	Description	Code	Description	Code	Description
A	0.60 ± 0.10 mm	I	1.25 ± 0.20 mm	Q	0.50 + 0.02/-0.05 mm
B	0.8 ± 0.15/-0.10 mm	J	1.15 ± 0.15 mm	R	3.10 ± 0.30 mm
C	1.25 ± 0.10 mm	K	0.50 ± 0.20 mm	S	0.80 ± 0.07 mm
D	1.40 ± 0.15 mm	L	0.30 ± 0.03 mm	T	0.85 ± 0.10 mm
E	1.60 ± 0.20 mm	M	0.95 ± 0.10 mm	U	0.50 ± 0.10 mm
F	2.00 ± 0.20 mm	N	0.50 ± 0.05 mm	V	0.20 ± 0.02 mm
G	2.50 ± 0.30 mm	O	3.50 ± 0.20 mm	X	0.80 ± 0.10 mm
H	2.80 ± 0.30 mm	P	1.60 + 0.3/-0.10 mm	Z	0.25 ± 0.03 mm

Table 9		Special Control Code	
Code	Description		
G	RoHS Compliant		
Q	Surface Coating (size 1206-2225)		

## 5. EXTERNAL DIMENSIONS

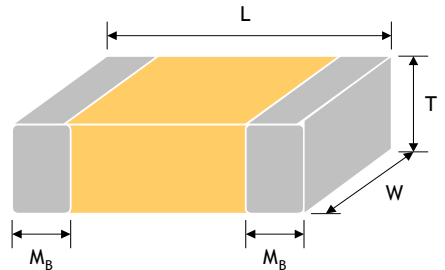
Size Inch (mm)	L (mm)	W (mm)	Code / T (mm)	M <sub>B</sub> (mm)	
0805(2012)	2.10±0.20	1.25±0.20	See No.4 Reference Table 8	0.50±0.20	
1206(3216)	3.30±0.30	1.60±0.20		0.60±0.20	
1210(3225)	3.30±0.40	2.50±0.30		0.75±0.35	
1808(4520)	4.50 +0.50/-0.30	2.00±0.25		0.75±0.35	
1812(4532)	4.50 +0.50/-0.30	3.20±0.30		0.75±0.35	
1825(4563)	4.50 +0.50/-0.30	6.30±0.40		0.75±0.35	
2211(5728)	5.70±0.40	2.80±0.30		0.85±0.35	
2220(5750)	5.70±0.40	5.00±0.40		0.85±0.35	
2225(5763)	5.70±0.40	6.30±0.40		0.85±0.35	

Fig.5-1 The outline of MLCC

## 6. GENERAL ELECTRICAL DATA

Dielectric	C0G	X7R						
Size	0805, 1206, 1210, 1808, 1812, 1825, 2211, 2220, 2225	0805, 1206, 1210, 1808, 1812, 1825, 2211, 2220, 2225						
Rated voltage (WVDC)	1000V, 1500V, 2000V, 3000V, 4000V	1000V, 1500V, 2000V, 3000V, 4000V						
Capacitance range*	0.5pF ~ 12nF	100pF ~ 390nF						
Capacitance tolerance	Reference to Table 5	Reference to Table 5						
Tan δ	<table border="1"> <thead> <tr> <th>Cap. Rang</th> <th>Q Spec.</th> </tr> </thead> <tbody> <tr> <td>Cap.&lt;30pF</td> <td>Q≥400+20C</td> </tr> <tr> <td>Cap.≥30pF</td> <td>Q≥1000</td> </tr> </tbody> </table>	Cap. Rang	Q Spec.	Cap.<30pF	Q≥400+20C	Cap.≥30pF	Q≥1000	≤2.5%
Cap. Rang	Q Spec.							
Cap.<30pF	Q≥400+20C							
Cap.≥30pF	Q≥1000							
Capacitance & Tan δ Test Condition	Measured at the condition of 30~70% related humidity							
	For 25°C at ambient temperature	Preconditioning for Class II MLCC : Perform a heat treatment at 150±10°C for 1 hour, then leave in ambient condition for 24±2 hours before measurement						
	<table border="1"> <thead> <tr> <th>Cap. Rang</th> <th>Test Condition</th> </tr> </thead> <tbody> <tr> <td>Cap.≤1000pF</td> <td>1.0±0.2Vrms, 1.0MHz±10%</td> </tr> <tr> <td>Cap.&gt;1000pF</td> <td>1.0±0.2Vrms, 1.0kHz±10%</td> </tr> </tbody> </table>	Cap. Rang	Test Condition	Cap.≤1000pF	1.0±0.2Vrms, 1.0MHz±10%	Cap.>1000pF	1.0±0.2Vrms, 1.0kHz±10%	1.0±0.2Vrms, 1.0kHz±10%, at 25°C ambient temperature
Cap. Rang	Test Condition							
Cap.≤1000pF	1.0±0.2Vrms, 1.0MHz±10%							
Cap.>1000pF	1.0±0.2Vrms, 1.0kHz±10%							
Insulation resistance at U <sub>r</sub>	≥100GΩ or RxC≥500Ω-F, whichever is smaller	≥10GΩ or RxC≥100Ω-F, whichever is smaller						
Operating temperature	-55°C to +125°C							
Capacitance characteristic	±30ppm/°C	±15%						
Termination	Cu(or Ag)/Ni/Sn (lead-free termination)							

## 7.CAPACITANCE RANGE

### 7-1. C0G

Dimension		0805	1206				1210			
Cap.(pF)	code	1000V	1000V	1500V	2000V	3000V	1000V	1500V	2000V	3000V
1.5	1R5	C	X	X	X					
1.8	1R8	C	X	X	X					
2.2	2R2	C	X	X	X					
2.7	2R7	C	X	X	X					
3.3	3R3	C	X	X	X					
3.9	3R9	C	X	X	X					
4.7	4R7	C	X	X	X					
5.0	5R0	C	X	X	X					
5.6	5R6	C	X	X	X					
6.8	6R8	C	X	X	X					
8.2	8R2	C	X	X	X					
10	100	C	X	X	X	E	M	M	M	F
12	120	C	X	X	X	E	M	M	M	F
15	150	C	X	X	X	E	M	M	M	F
18	180	C	X	X	X	E	M	M	M	F
22	220	C	X	X	X	E	M	M	M	F
27	270	C	X	X	X	E	M	M	M	F
33	330	C	X	M	M	E	M	M	M	F
39	390	C	X	M	M	E	M	M	M	F
47	470	C	M	M	M	E	M	M	M	F
56	560	C	M	C	C	E	M	C	C	F
68	680	C	M	C	C	E	M	C	C	F
82	820	C	C	C	C	E	M	C	C	F
100	101	C	C	C	C		C	C	C	F
120	121	C	C	E	E		C	C	C	F
150	151	C	C	E	E		C	E	E	F
180	181	C	E	E	E		C	E	E	F
220	221	C	E	E	E		E	E	E	F
270	271	C	E	E	E		E	E	E	G
330	331	C	E	E	E		E	E	E	
390	391		E	E	E		E	E	E	
470	471		E	E	E		E	E	E	
560	561		E				E	E	E	
680	681		E				E	E	E	
820	821		E				E	E	E	
1000	102		E				E	F	F	
1200	122		E				E	F	F	
1500	152						F	G	G	
1800	182						G	G	G	
2200	222						G			
2700	272						G			
3300	332						G			
3900	392						G			

## 7.CAPACITANCE RANGE(Con.)

### 7-1. C0G

Dimension		1808				1812				1825			
Cap.(pF)	code	1000V	1500V	2000V	3000V	1000V	1500V	2000V	3000V	1000V	1500V	2000V	3000V
1.5	1R5												
1.8	1R8												
2.2	2R2	C	C	C	C								
2.7	2R7	C	C	C	C								
3.3	3R3	C	C	C	C								
3.9	3R9	C	C	C	C								
4.7	4R7	C	C	C	C								
5.0	5R0	C	C	C	C								
5.6	5R6	C	C	C	C								
6.8	6R8	C	C	C	C								
8.2	8R2	C	C	C	C								
10	100	C	C	C	C	C	C	C	C	F	F	F	F
12	120	C	C	C	C	C	C	C	C	F	F	F	F
15	150	C	C	C	C	C	C	C	C	F	F	F	F
18	180	C	C	C	C	C	C	C	C	F	F	F	F
22	220	C	C	C	C	C	C	C	C	F	F	F	F
27	270	C	C	C	C	C	C	C	C	F	F	F	F
33	330	C	C	C	C	C	C	C	C	F	F	F	F
39	390	C	C	C	C	C	C	C	C	F	F	F	F
47	470	C	C	C	C	C	C	C	C	F	F	F	F
56	560	C	C	C	C	C	C	C	C	F	F	F	F
68	680	C	C	C	C	C	C	C	C	F	F	F	F
82	820	C	C	C	C	C	C	C	C	F	F	F	F
100	101	C	C	C	F	C	C	C	C	F	F	F	F
120	121	C	C	C	F	C	C	C	C	F	F	F	F
150	151	C	F	F	F	C	C	C	C	F	F	F	F
180	181	C	F	F	F	C	C	C	F	F	F	F	F
220	221	C	F	F	F	C	C	C	F	F	F	F	F
270	271	F	F	F	F	C	F	F	F	F	F	F	F
330	331	F	F	F	F	C	F	F	F	F	F	F	F
390	391	F	F	F	F	C	F	F	F	F	F	F	F
470	471	F	F	F	F	F	F	F	F	F	F	F	F
560	561	F	F	F	F	F	F	F	F	F	F	F	F
680	681	F	F	F		F	F	F	F	F	F	F	G
820	821	F	F	F		F	F	F	G	F	F	F	G
1000	102	F	F	F		F	F	F	G	F	F	F	G
1200	122	F	F	F		F	F	F		F	F	F	G
1500	152	F	F	F		F	F	F		F	G	G	G
1800	182	F	F	F		F	F	F		F	G	G	G
2200	222	F				F	F	F		F	G	G	G
2700	272	F				F	G	G		F	G	G	G
3300	332	F				F	G	G		F	G	G	
3900	392					G				G	G	G	
4700	472					G				G	G	G	
5600	562					G				G	G	G	
6800	682									G	G	G	
8200	822									G	G	G	
10000	103									G			
12000	123									G			

## 7.CAPACITANCE RANGE(Con.)

### 7-1. C0G

Dimension		2220					2225				
Cap.(pF)	code	1000V	1500V	2000V	3000V	4000V	1000V	1500V	2000V	3000V	4000V
1.5	1R5										
1.8	1R8										
2.2	2R2										
2.7	2R7										
3.3	3R3										
3.9	3R9										
4.7	4R7										
5.0	5R0										
5.6	5R6										
6.8	6R8										
8.2	8R2										
10	100	F	F	F	F		F	F	F	F	
12	120	F	F	F	F		F	F	F	F	
15	150	F	F	F	F		F	F	F	F	
18	180	F	F	F	F		F	F	F	F	
22	220	F	F	F	F		F	F	F	F	
27	270	F	F	F	F	F	F	F	F	F	F
33	330	F	F	F	F	F	F	F	F	F	F
39	390	F	F	F	F	F	F	F	F	F	F
47	470	F	F	F	F	F	F	F	F	F	F
56	560	F	F	F	F	F	F	F	F	F	F
68	680	F	F	F	F	F	F	F	F	F	F
82	820	F	F	F	F	F	F	F	F	F	F
100	101	F	F	F	F	F	F	F	F	F	F
120	121	F	F	F	F	F	F	F	F	F	F
150	151	F	F	F	F	F	F	F	F	F	F
180	181	F	F	F	F	F	F	F	F	F	F
220	221	F	F	F	F	F	F	F	F	F	F
270	271	F	F	F	F	G	F	F	F	F	G
330	331	F	F	F	G	G	F	F	F	F	
390	391	F	F	F	G		F	F	F	F	
470	471	F	F	F	G		F	F	F	F	
560	561	F	F	F	G		F	F	F	F	
680	681	F	F	F	G		F	F	F	F	
820	821	F	F	F	G		F	G	G	G	
1000	102	F	F	F	G		F	G	G	G	
1200	122	G	G	G	G		F	G	G	G	
1500	152	G	G	G	G		F	G	G	G	
1800	182	G	G	G	G		F	G	G	G	
2200	222	G	G	G	G		F	G	G	G	
2700	272	G	G	G	G		F	G	G	G	
3300	332	G	G	G			F	G	G	G	
3900	392	G	G	G			F	G	G		
4700	472	G	G	G			F	G	G		
5600	562	G	G	G			G	G	G		
6800	682	G	G	G			G	G	G		
8200	822	G	G	G			G	G	G		
10000	103	G					G	G	G		
12000	123	G					G				

## 7.CAPACITANCE RANGE(Con.)

### 7-2. X7R

Dimension		0805	1206			1210			1808				
Cap.(pF)	code	1000V	1000V	1500V	2000V	1000V	1500V	2000V	1000V	1500V	2000V	3000V	4000V
100	101	X	C	C	C								
120	121	X	C	C	C								
150	151	X	C	C	C				C	C	C	C	F
180	181	X	C	C	C				C	C	C	C	F
220	221	X	C	C	C	C	E	E	C	C	C	C	F
270	271	X	C	C	C	C	E	E	C	C	C	C	F
330	331	X	C	C	C	C	E	E	C	C	C	F	F
390	391	X	C	C	C	C	E	E	C	C	C	F	F
470	471	X	C	C	C	C	E	E	C	C	C	F	F
560	561	X	C	C	C	C	E	E	C	C	C	F	F
680	681	X	C	C	C	C	E	E	C	C	C	F	F
820	821	X	C	C	C	C	E	E	C	C	C	F	F
1000	102	X	C	C	C	C	E	E	C	C	C	F	F
1200	122	X	C	E	E	C	F	F	C	F	F	F	
1500	152	C	C	E	E	C	F	F	C	F	F	F	
1800	182	C	C	E	E	C	F	F	C	F	F	F	
2200	222	C	C	E	E	C	F	F	C	F	F	F	
2700	272	C	C	E	E	C	G	G	C	F	F		
3300	332	C	C	E	E	C	G	G	C	F	F		
3900	392	C	C	E		E	G	G	C	F	F		
4700	472	C	C	E		E	G	G	C	F	F		
5600	562	C	C			E	G	G	F	F	F		
6800	682	C	C			E	G	G	F	F	F		
8200	822	C	C			E	G	G	F				
10000	103		C			E			F				
12000	123		E			E			F				
15000	153		E			E			F				
18000	183		E			E			F				
22000	223		E			E			F				
27000	273					E			F				
33000	333					E			F				
39000	393					F			F				
47000	473					G			F				
56000	563					G			F				
68000	683					G							



## 7.CAPACITANCE RANGE(Con.)

### 7-2. X7R

Dimension		1812					1825				
Cap.(pF)	code	1000V	1500V	2000V	3000V	4000V	1000V	1500V	2000V	3000V	4000V
270	271	C	C	C	E	F					F
330	331	C	C	C	E	F					F
390	391	C	C	C	E	F					F
470	471	C	C	C	E	F					F
560	561	C	C	C	E	F					F
680	681	C	C	C	F	F					F
820	821	C	C	C	F	F					F
1000	102	C	C	C	F	F	F	F	F	F	F
1200	122	C	C	C	F	G	F	F	F	F	G
1500	152	C	C	C	F	G	F	F	F	F	G
1800	182	C	E	E	G	G	F	F	F	F	G
2200	222	C	E	E	G		F	F	F	F	
2700	272	C	E	E	G		F	F	F	F	
3300	332	C	F	F	G		F	F	F	F	
3900	392	C	F	F	G		F	F	F	F	
4700	472	C	F	F	G		F	F	F	F	
5600	562	C	G	G			F	F	F	G	
6800	682	C	G	G			F	F	F	G	
8200	822	C	G	G			F	F	F	G	
10000	103	E	G	G			F	F	F	G	
12000	123	F					F	G	G	H	
15000	153	F					F	G	G	H	
18000	183	G					F	G	G	H	
22000	223	G					F	G	G		
27000	273	G					F	H	H		
33000	333	G					F	H	H		
39000	393	G					F	H	H		
47000	473	G					F	H	H		
56000	563	G					F	H	H		
68000	683	G					F				
82000	823	G					G				
100000	104	G					G				
120000	124						H				
150000	154						H				
180000	184						H				
220000	224						H				
270000	274						H				
330000	334						H				

## 7.CAPACITANCE RANGE(Con.)

### 7-2. X7R

Dimension		2211		2220					2225				
Cap.(pF)	code	3000V	4000V	1000V	1500V	2000V	3000V	4000V	1000V	1500V	2000V	3000V	4000V
270	271	F	F					F					F
330	331	F	F					F					F
390	391	F	F					F					F
470	471	F	F					F					F
560	561	F	F					F					F
680	681	F	F					F					F
820	821	F	F					F					F
1000	102	F	F	F	F	F	F	F	F	F	F	F	F
1200	122	G	G	F	F	F	F	G	F	F	F	F	G
1500	152	G	G	F	F	F	F	G	F	F	F	F	G
1800	182	G	G	F	F	F	F	G	F	F	F	F	G
2200	222	G		F	F	F	F		F	F	F	F	
2700	272	G		F	F	F	F		F	F	F	F	
3300	332	G		F	F	F	F		F	F	F	F	
3900	392			F	F	F	F		F	F	F	F	
4700	472			F	F	F	F		F	F	F	F	
5600	562			F	F	F	F		F	F	F	G	
6800	682			F	F	F	G		F	F	F	G	
8200	822			F	G	G	G		F	F	F	G	
10000	103			F	G	G	G		F	F	F	G	
12000	123			F	G	G	H		F	G	G	G	
15000	153			F	G	G	H		F	G	G	G	
18000	183			F	H	H	H		F	G	G	H	
22000	223			F	H	H			F	G	G		
27000	273			F	H	H			F	G	G		
33000	333			F	H	H			F	G	G		
39000	393			F	H	H			F	G	H		
47000	473			F	H	H			F	G	H		
56000	563			F	H	H			F	G	H		
68000	683			G					F	G			
82000	823			G					F	G			
100000	104			G					G	G			
120000	124			G					H				
150000	154			H					H				
180000	184			H					H				
220000	224			H					H				
270000	274			H					H				
330000	334			H					H				
390000	394			H					H				

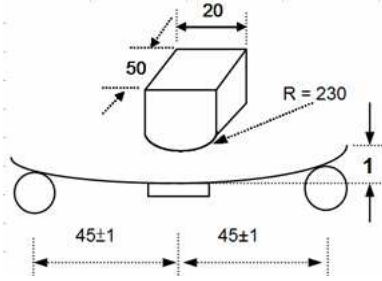
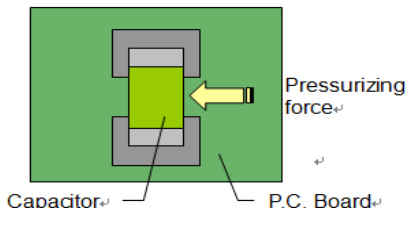
## 8.RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Test Condition	Requirements																										
1.	Visual and Dimensions	---	* No remarkable defect. * Dimensions to confirm to individual specification sheet.																										
2.	Capacitance		* Shall not exceed the limits given in the detailed spec.																										
3.	Q/ D.F. (Dissipation Factor)	* Class I : C0G Cap≤1000pF, 1.0±0.2Vrms, 1MHz±10%. Cap>1000pF, 1.0±0.2Vrms, 1KHz±10%. * Class II : X7R 1.0±0.2Vrms, 1kHz±10%.	<table border="1"> <thead> <tr> <th>Dielectric</th> <th>Rated vol.(V)</th> <th>Q/D.F.</th> <th>Remark</th> </tr> </thead> <tbody> <tr> <td rowspan="2">Class I (C0G)</td> <td rowspan="2">All</td> <td>Q≥1000</td> <td>Cap.≥30pF</td> </tr> <tr> <td>Q≥400+20C</td> <td>Cap.&lt;30pF</td> </tr> <tr> <td>Class II (X7R)</td> <td>All</td> <td>D.F.≤2.5%</td> <td></td> </tr> </tbody> </table>	Dielectric	Rated vol.(V)	Q/D.F.	Remark	Class I (C0G)	All	Q≥1000	Cap.≥30pF	Q≥400+20C	Cap.<30pF	Class II (X7R)	All	D.F.≤2.5%													
Dielectric	Rated vol.(V)	Q/D.F.	Remark																										
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4.	Temperature Coefficient	* With no electrical load. <table border="1"> <thead> <tr> <th>T.C.</th> <th>Operating temp.</th> </tr> </thead> <tbody> <tr> <td>C0G</td> <td>-55~125°C at 25°C</td> </tr> <tr> <td>X7R</td> <td>-55~125°C at 25°C</td> </tr> </tbody> </table>	T.C.	Operating temp.	C0G	-55~125°C at 25°C	X7R	-55~125°C at 25°C	<table border="1"> <thead> <tr> <th>T.C.</th> <th>Capacitance change</th> </tr> </thead> <tbody> <tr> <td>C0G</td> <td>Within ±30ppm/°C</td> </tr> <tr> <td>X7R</td> <td>Within ±15%</td> </tr> </tbody> </table>	T.C.	Capacitance change	C0G	Within ±30ppm/°C	X7R	Within ±15%														
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5.	Insulation Resistance	<table border="1"> <thead> <tr> <th>Rated vol.(V)</th> <th>Apply voltage</th> <th>Test condition</th> </tr> </thead> <tbody> <tr> <td>&gt;500</td> <td>500VDC</td> <td>60 sec.</td> </tr> </tbody> </table>	Rated vol.(V)	Apply voltage	Test condition	>500	500VDC	60 sec.	<table border="1"> <thead> <tr> <th>Dielectric</th> <th>Requirements</th> </tr> </thead> <tbody> <tr> <td>Class I</td> <td>≥100GΩ or RxC≥500Ω-F, whichever is smaller</td> </tr> <tr> <td>Class II</td> <td>≥10GΩ or RxC≥100Ω-F, whichever is smaller</td> </tr> </tbody> </table>	Dielectric	Requirements	Class I	≥100GΩ or RxC≥500Ω-F, whichever is smaller	Class II	≥10GΩ or RxC≥100Ω-F, whichever is smaller														
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Class II	≥10GΩ or RxC≥100Ω-F, whichever is smaller																												
6.	Solderability	* Solder temperature : 235±5°C for (0603~1210). * Solder temperature : 245±5°C for (1808~2225). * Dipping time : 2±0.5 sec.	* 75% min. coverage of all metalized area.																										
7.	Dielectric Strength	<table border="1"> <thead> <tr> <th>Rated vol.(V)</th> <th>Condition</th> </tr> </thead> <tbody> <tr> <td>630≤V≤3000V</td> <td>1.2 times of UR</td> </tr> <tr> <td>3000&lt;V≤5000V</td> <td>1.1 times of UR</td> </tr> </tbody> </table> * Duration : 1 to 5 sec. * Charge and discharge current less than 50mA.	Rated vol.(V)	Condition	630≤V≤3000V	1.2 times of UR	3000<V≤5000V	1.1 times of UR	* No evidence of damage or flashover during test.																				
Rated vol.(V)	Condition																												
630≤V≤3000V	1.2 times of UR																												
3000<V≤5000V	1.1 times of UR																												
8.	Resistance to Soldering Heat	* Solder temperature : 260±5°C. * Dipping time : 10±1 sec. * Preheating : 120 to 150°C for 1 minute before immerse the capacitor in a eutectic solder. * Before initial measurement (Class II only) : Perform 150 +0/-10°C for 1 hr and then set for 48±4 hrs at room temp. * Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).	* No remarkable damage. <table border="1"> <thead> <tr> <th>Dielectric</th> <th>Cap. change</th> <th>Q/D.F. &amp; I.R.</th> </tr> </thead> <tbody> <tr> <td>Class I (C0G)</td> <td>Within ±2.5% or ±0.25pF, whichever is larger</td> <td rowspan="2">To meet initial requirement</td> </tr> <tr> <td>Class II (X7R)</td> <td>Within ±7.5%</td> </tr> </tbody> </table> * 25% max. leaching on each edge.	Dielectric	Cap. change	Q/D.F. & I.R.	Class I (C0G)	Within ±2.5% or ±0.25pF, whichever is larger	To meet initial requirement	Class II (X7R)	Within ±7.5%																		
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Class II (X7R)	Within ±7.5%																												
9.	Temperature Cycle	* Conduct the five cycles according to the temperatures and time. <table border="1"> <thead> <tr> <th>Step</th> <th>Temp.(°C)</th> <th>Time(min.)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>Min. operating temp. +0/-3</td> <td>30±3</td> </tr> <tr> <td>2</td> <td>Room temp.</td> <td>2~3</td> </tr> <tr> <td>3</td> <td>Max. operating temp. +3/-0</td> <td>30±3</td> </tr> <tr> <td>4</td> <td>Room temp.</td> <td>2~3</td> </tr> </tbody> </table> * Before initial measurement (Class II only) : Perform 150 +0/-10°C for 1 hr and then set for 48±4 hrs at room temp. * Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).	Step	Temp.(°C)	Time(min.)	1	Min. operating temp. +0/-3	30±3	2	Room temp.	2~3	3	Max. operating temp. +3/-0	30±3	4	Room temp.	2~3	* No remarkable damage. <table border="1"> <thead> <tr> <th>Dielectric</th> <th>I.R.</th> <th>Cap. change</th> <th>Q/D.F.</th> </tr> </thead> <tbody> <tr> <td>Class I (C0G)</td> <td rowspan="2">To meet initial requirement</td> <td>Within ±2.5% or ±0.25pF, whichever is larger</td> <td>≤1.0(Q) × initial requirement</td> </tr> <tr> <td>Class II (X7R)</td> <td>Within ±7.5%</td> <td>≤1.5(D.F.) × initial requirement</td> </tr> </tbody> </table>	Dielectric	I.R.	Cap. change	Q/D.F.	Class I (C0G)	To meet initial requirement	Within ±2.5% or ±0.25pF, whichever is larger	≤1.0(Q) × initial requirement	Class II (X7R)	Within ±7.5%	≤1.5(D.F.) × initial requirement
Step	Temp.(°C)	Time(min.)																											
1	Min. operating temp. +0/-3	30±3																											
2	Room temp.	2~3																											
3	Max. operating temp. +3/-0	30±3																											
4	Room temp.	2~3																											
Dielectric	I.R.	Cap. change	Q/D.F.																										
Class I (C0G)	To meet initial requirement	Within ±2.5% or ±0.25pF, whichever is larger	≤1.0(Q) × initial requirement																										
Class II (X7R)		Within ±7.5%	≤1.5(D.F.) × initial requirement																										

## 8.RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Test Condition	Requirements																	
10.	<b>Humidity (Damp Heat) Steady State</b>	* Test temp. : 40±2°C. * Humidity : 90~95%RH. * Test time : 500 +24/-0 hrs. * Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).	* No remarkable damage. <table border="1"> <thead> <tr> <th>Dielectric</th> <th>I.R.</th> <th>Cap. change</th> <th colspan="2">Q/D.F.</th> </tr> </thead> <tbody> <tr> <td rowspan="2">Class I (C0G)</td> <td rowspan="2">≥1G or RxC≥50Ω-F, whichever is smaller</td> <td rowspan="2">Within ±5.0% or ± 0.5pF, whichever is larger</td> <td>Cap.≥30pF</td> <td>Q≥350</td> </tr> <tr> <td>10pF≤Cap.&lt;30pF</td> <td>Q≥275+2.5C</td> </tr> <tr> <td>Class II (X7R)</td> <td></td> <td>Within ±12.5%</td> <td colspan="2">D.F.≤200% of initial requirement</td> </tr> </tbody> </table>	Dielectric	I.R.	Cap. change	Q/D.F.		Class I (C0G)	≥1G or RxC≥50Ω-F, whichever is smaller	Within ±5.0% or ± 0.5pF, whichever is larger	Cap.≥30pF	Q≥350	10pF≤Cap.<30pF	Q≥275+2.5C	Class II (X7R)		Within ±12.5%	D.F.≤200% of initial requirement	
			Dielectric	I.R.	Cap. change	Q/D.F.														
Class I (C0G)	≥1G or RxC≥50Ω-F, whichever is smaller	Within ±5.0% or ± 0.5pF, whichever is larger	Cap.≥30pF	Q≥350																
			10pF≤Cap.<30pF	Q≥275+2.5C																
Class II (X7R)		Within ±12.5%	D.F.≤200% of initial requirement																	
11.	<b>Humidity (Damp Heat) Load</b>	* Reflow solder the capacitors on a P.C. Board before test. * Test temp. : 40±2°C. * Humidity : 90~95% RH. * Test time : 500 +24/-0hrs. * To apply voltage : 500V. * Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).	* No remarkable damage. <table border="1"> <thead> <tr> <th>Dielectric</th> <th>I.R.</th> <th>Cap. change</th> <th colspan="2">Q/D.F.</th> </tr> </thead> <tbody> <tr> <td rowspan="2">Class I (C0G)</td> <td rowspan="2">≥1GΩ or RxC≥50Ω-F, whichever is smaller</td> <td rowspan="2">Within ±7.5% or ±0.75pF, whichever is larger</td> <td>Cap.≥30pF</td> <td>Q≥350</td> </tr> <tr> <td>10pF≤Cap.&lt;30pF</td> <td>Q≥275+2.5C</td> </tr> <tr> <td>Class II (X7R)</td> <td></td> <td>Within ±12.5%</td> <td colspan="2">D.F.≤200% of initial requirement</td> </tr> </tbody> </table>	Dielectric	I.R.	Cap. change	Q/D.F.		Class I (C0G)	≥1GΩ or RxC≥50Ω-F, whichever is smaller	Within ±7.5% or ±0.75pF, whichever is larger	Cap.≥30pF	Q≥350	10pF≤Cap.<30pF	Q≥275+2.5C	Class II (X7R)		Within ±12.5%	D.F.≤200% of initial requirement	
			Dielectric	I.R.	Cap. change	Q/D.F.														
Class I (C0G)	≥1GΩ or RxC≥50Ω-F, whichever is smaller	Within ±7.5% or ±0.75pF, whichever is larger	Cap.≥30pF	Q≥350																
			10pF≤Cap.<30pF	Q≥275+2.5C																
Class II (X7R)		Within ±12.5%	D.F.≤200% of initial requirement																	
12.	<b>High Temperature Load (Endurance)</b>	* Test temp. : 125±3°C. * Apply voltage : 110% of rated voltage. * Test time : 1000 +24/-0 hrs. * Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).	* No remarkable damage. <table border="1"> <thead> <tr> <th>Dielectric</th> <th>I.R.</th> <th>Cap. change</th> <th>Q/D.F.</th> </tr> </thead> <tbody> <tr> <td>Class I (C0G)</td> <td rowspan="2">≥1GΩ or RxC≥50Ω-F, whichever is smaller</td> <td>Within ±3.0% or ±0.3pF, whichever is larger</td> <td rowspan="2">D.F.≤200% of initial requirement</td> </tr> <tr> <td>Class II (X7R)</td> <td>Within ±12.5%</td> </tr> </tbody> </table>	Dielectric	I.R.	Cap. change	Q/D.F.	Class I (C0G)	≥1GΩ or RxC≥50Ω-F, whichever is smaller	Within ±3.0% or ±0.3pF, whichever is larger	D.F.≤200% of initial requirement	Class II (X7R)	Within ±12.5%							
			Dielectric	I.R.	Cap. change	Q/D.F.														
Class I (C0G)	≥1GΩ or RxC≥50Ω-F, whichever is smaller	Within ±3.0% or ±0.3pF, whichever is larger	D.F.≤200% of initial requirement																	
Class II (X7R)		Within ±12.5%																		

## 8. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

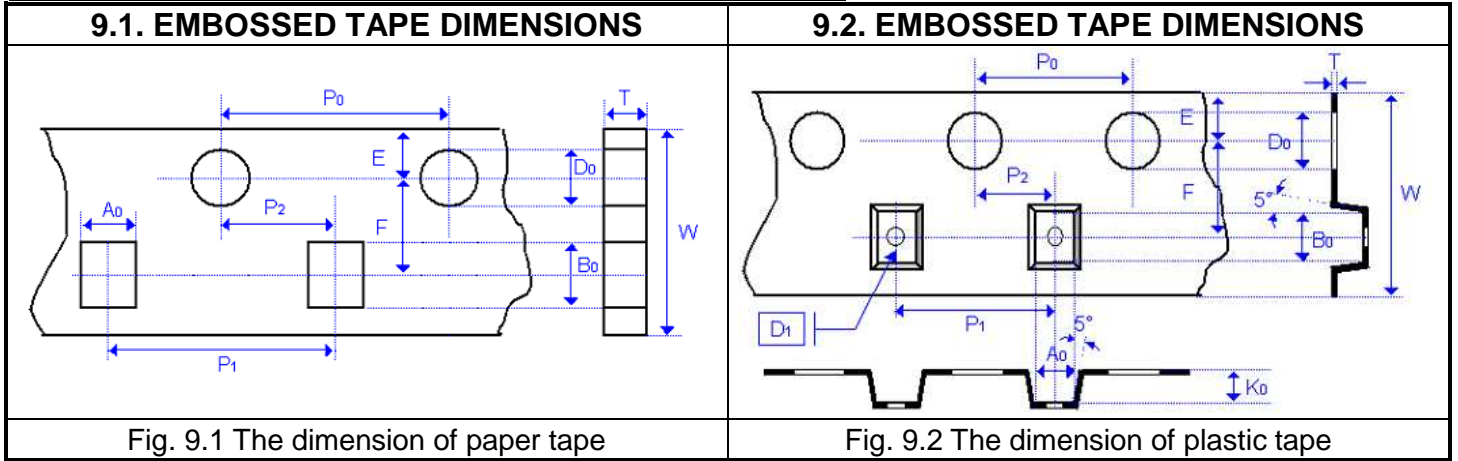
No.	Item	Test Condition	Requirements						
13	Resistance to Flexure of Substrate	<p>* The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1mm per second until the deflection becomes 1mm.</p>  <p>Unit : mm</p>	<p>* No remarkable damage.</p> <table border="1"> <thead> <tr> <th>Dielectric</th> <th>Cap. Change</th> </tr> </thead> <tbody> <tr> <td>Class I (C0G)</td> <td>Within ±3.0% or ±0.3pF, whichever is larger</td> </tr> <tr> <td>Class II (X7R)</td> <td>Within ±12.5%</td> </tr> </tbody> </table> <p>(This capacitance change means the change of capacitance under specified flexure of substrate from the capacitance measured before the test)</p>	Dielectric	Cap. Change	Class I (C0G)	Within ±3.0% or ±0.3pF, whichever is larger	Class II (X7R)	Within ±12.5%
Dielectric	Cap. Change								
Class I (C0G)	Within ±3.0% or ±0.3pF, whichever is larger								
Class II (X7R)	Within ±12.5%								
14.	Adhesive Strength of Termination	<p>* Capacitors mounted on a substrate. A force of 5N(≤0603) or 10N(&gt;0603) applied perpendicular to the place of substrate and parallel the line joining the center of terminations for 10±1 second.</p> 	<p>* No remarkable damage or removal of the terminations.</p>						
15.	Vibration Resistance	<p>* Vibration frequency : 10~55 Hz/min. * Total amplitude : 1.5mm. * Test time : 6 hrs (Two hrs each in three mutually perpendicular directions.)</p>	<p>* No remarkable damage. * Cap. change and Q/D.F. : To meet initial spec.</p>						

## 9. PACKAGE DIMENSION AND QUANTITY

Size	Thickness (mm)	Paper tape		Plastic tape	
		7" reel	13" reel	7" reel	13" reel
0402(1005)	0.50±0.05	10k	50K	-	-
0603(1608)	0.80±0.07	4k	15k	-	-
	0.80 +0.15/-0.10	4k	15k	-	-
0805(2012)	0.60±0.10	4k	15k	-	-
	0.80±0.10	4k	15k	-	-
	1.25±0.10	-	-	3k	10k
	1.25±0.20	-	-	3k	-
1206(3216)	0.80±0.10	4k	15k	-	-
	0.95±0.10	-	-	3k	10k
	1.25±0.10	-	-	3k	10k
	1.60±0.20	-	-	2k	-
1210(3225)	0.95±0.10	-	-	3k	10k
	1.25±0.10	-	-	3k	10k
	1.60±0.20	-	-	2k	-
	2.50±0.30	-	-	1k	-
1808(4520)	1.25±0.10	-	-	2k	-
	1.60±0.20	-	-	2k	-
	2.00±0.20	-	-	1k	-
1812(4532)	1.25±0.10	-	-	1k	-
	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	-
1825(4563)	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	-
	2.80±0.30	-	-	0.5k	-
2211(5728)	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	-
	2.80±0.30	-	-	0.5k	-
2220(5750)	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	-
	2.80±0.30	-	-	0.5k	-
2225(5763)	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	-
	2.80±0.30	-	-	0.5k	-

Unit : pcs

## 9. PACKAGE DIMENSION AND QUANTITY



Size	0603		0805		1206		
Chip Thickness	0.80±0.07	0.80 +0.15/-0.1	0.80±0.10	1.25±0.10 1.25±0.20	0.80±0.10	0.95±0.10 1.25±0.10	1.60±0.20 1.60+0.3/-0.1
A <sub>0</sub>	1.00 +0.05/-0.10	1.02 +0.05/-0.10	1.50±0.10	<1.65	2.00±0.10	<2.00	<2.00
B <sub>0</sub>	1.80±0.10	1.80±0.10	2.30±0.10	<2.40	3.50±0.10	<3.60	<3.70
T	0.95±0.05	0.97±0.05	0.95±0.05	0.23±0.05	0.95±0.05	0.23±0.05	0.23±0.05
K <sub>0</sub>	-	-	-	<2.50	-	<2.50	<2.50
W	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10
P <sub>0</sub>	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
10xP <sub>0</sub>	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20
P <sub>1</sub>	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
P <sub>2</sub>	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05
D <sub>0</sub>	1.55±0.05	1.55±0.05	1.55±0.05	1.50 +0.10/-0	1.55±0.05	1.50 +0.10/-0	1.50 +0.10/-0
D <sub>1</sub>	-	-	-	1.00±0.10	-	1.00±0.10	1.00±0.10
E	1.75±0.05	1.75±0.05	1.75±0.05	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10
F	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05
Unit :	mm	mm	mm	mm	mm	mm	mm

Size	1210		1808		1812	
Chip Thickness	0.95±0.10 1.25±0.10 1.60±0.20	2.50±0.30	1.25±0.10 1.60±0.20	2.00±0.20	1.25±0.10 1.60±0.20 2.00±0.20	2.50±0.30
A <sub>0</sub>	<3.05	<3.10	<2.50	<2.50	<3.90	<3.90
B <sub>0</sub>	<3.80	<4.00	<5.30	<5.30	<5.30	<5.30
T	0.23±0.05	0.23±0.05	0.25±0.05	0.25±0.05	0.25±0.05	0.25±0.05
K <sub>0</sub>	<2.50	<3.50	<2.50	<2.50	<2.50	<3.00
W	8.00±0.10	8.00±0.10	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20
P <sub>0</sub>	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
10xP <sub>0</sub>	40.00±0.20	40.0±0.10	40.0±0.20	40.0±0.20	40.00±0.20	40.00±0.20
P <sub>1</sub>	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	8.00±0.10	8.00±0.10
P <sub>2</sub>	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05
D <sub>0</sub>	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0
D <sub>1</sub>	1.00±0.10	1.00±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10
E	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10
F	3.50±0.05	3.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05
Unit :	mm	mm	mm	mm	mm	mm

## 9. PACKAGE DIMENSION AND QUANTITY

Size	1825		2211		2220		2225	
Chip Thickness	1.60±0.20 2.00±0.20	2.50±0.30	1.60±0.20 2.00±0.20	2.50±0.30	1.40±0.15 1.60±0.20 2.00±0.20	2.50±0.30	1.60±0.20 2.00±0.20	2.50±0.30
A <sub>0</sub>	<6.80	<6.80	<3.30	<3.30	<5.80	<5.80	<6.80	<6.80
B <sub>0</sub>	<5.30	<5.30	<6.50	<6.50	<6.50	<6.50	<6.50	<6.50
T	0.30±0.10	0.30±0.10	0.30±0.10	0.30±0.10	0.30±0.10	0.30±0.10	0.30±0.10	0.30±0.10
K <sub>0</sub>	<2.50	<3.10	<2.50	<3.10	<2.50	<3.10	<2.50	<3.10
W	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20	12.0±0.20
P <sub>0</sub>	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
10xP <sub>0</sub>	40.00±0.20	40.00±0.20	40.0±0.20	40.0±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20
P <sub>1</sub>	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10
P <sub>2</sub>	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05
D <sub>0</sub>	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0
D <sub>1</sub>	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10
E	1.75±0.1	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10
F	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05
Unit :	mm	mm	mm	mm	mm	mm	mm	mm

### 9.3. REEL DIMENSIONS

Size	0402, 0603, 0805, 1206, 1210			1808, 1812, 1825, 2211, 2220, 2225
Reel size	7"	7"	13"	7"
C	13.0 +0.5/-0.2	13.0 +0.5/-0.2	13.0 +0.5/-0.2	13.0 +0.5/-0.2
W <sub>1</sub>	8.4 +1.5/-0	12.4 +2.0/-0	8.4 +1.5/-0	8.4 +1.5/-0
A	178.0 ±0.10	178.0 ±0.10	330.0 ±1.0	178.0 ±0.10
N	60.0 +1.0/-0	80.0 ±1.0	100 ±1.0	60.0 +1.0/-0

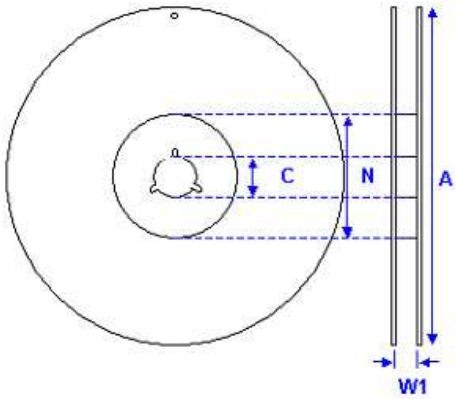


Fig. 4 The dimension of reel



## 10. APPLICATION NOTES

### STORAGE

To prevent the damage of solderability of terminations, the following storage conditions are recommended :

Indoors under 5 ~ 40°C and 20% ~ 70% RH.

No harmful gases containing sulfuric acid, ammonia, hydrogen sulfide or chlorine.

Packaging should not be opened until the capacitors are required for use. If opened, the pack should be re-sealed as soon as is practicable. Taped product should be stored out of direct sunlight, which might promote deterioration in tape or adhesion performance. The product is recommended to be used within 12 months after shipment and checked the solderability before use.

### HANDLING

Chip capacitors are dense, hard, brittle, and abrasive materials. They are liable to suffer mechanical damage, in the form of cracks or chips. Chip Capacitors should be handled with care to avoid contamination or damage. To use vacuum or plastic tweezers to pick up or plastic tweezers is recommended for manual placement. Tape and reeled packages are suitable for automatic pick and placement machine.

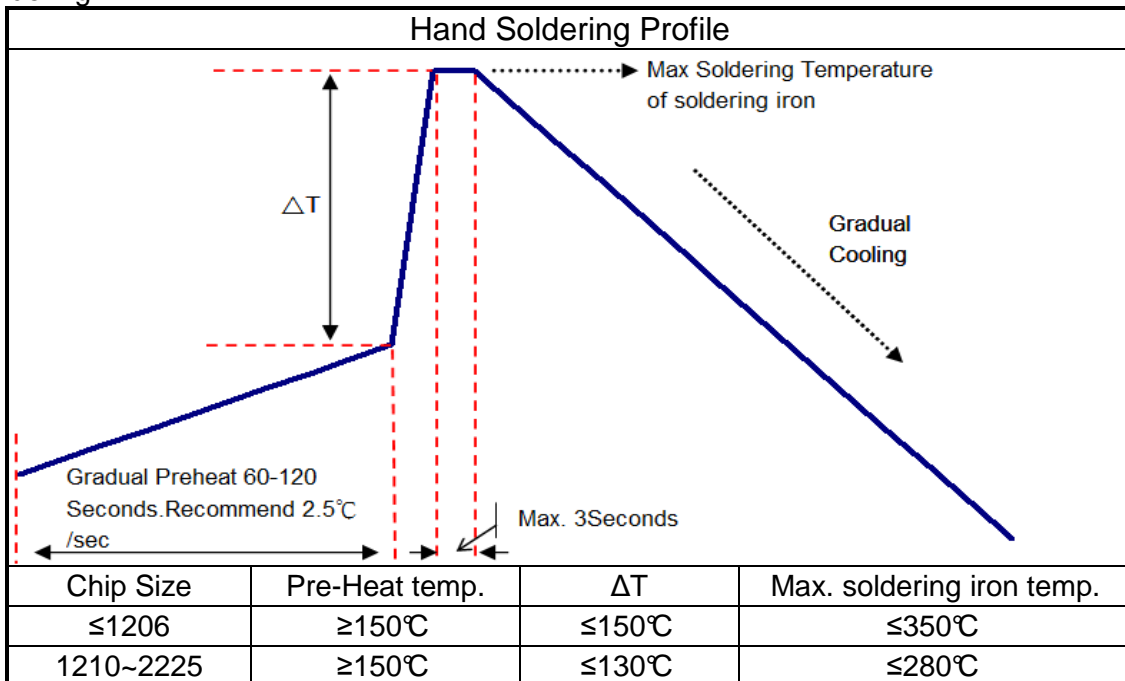
### PREHEAT

In order to minimize the risk of thermal shock during soldering, a carefully controlled preheat is required. The rate of preheat should not exceed 3°C per second.

### SOLDERING

Use mildly activated rosin RA and RMA fluxes do not use activated flux. The amount of solder in each solder joint should be controlled to prevent the damage of chip capacitors caused by the stress between solder, chips, and substrate.

a.) Hand soldering:



\* Soldering iron tip diameter  $\leq 1.0$  mm and wattage max. 20W.

\* The Capacitors shall be pre-heated and that the temperature gradient between the devices and the tip of the soldering iron.

\* The required amount of solder shall be melted on the soldering tip.

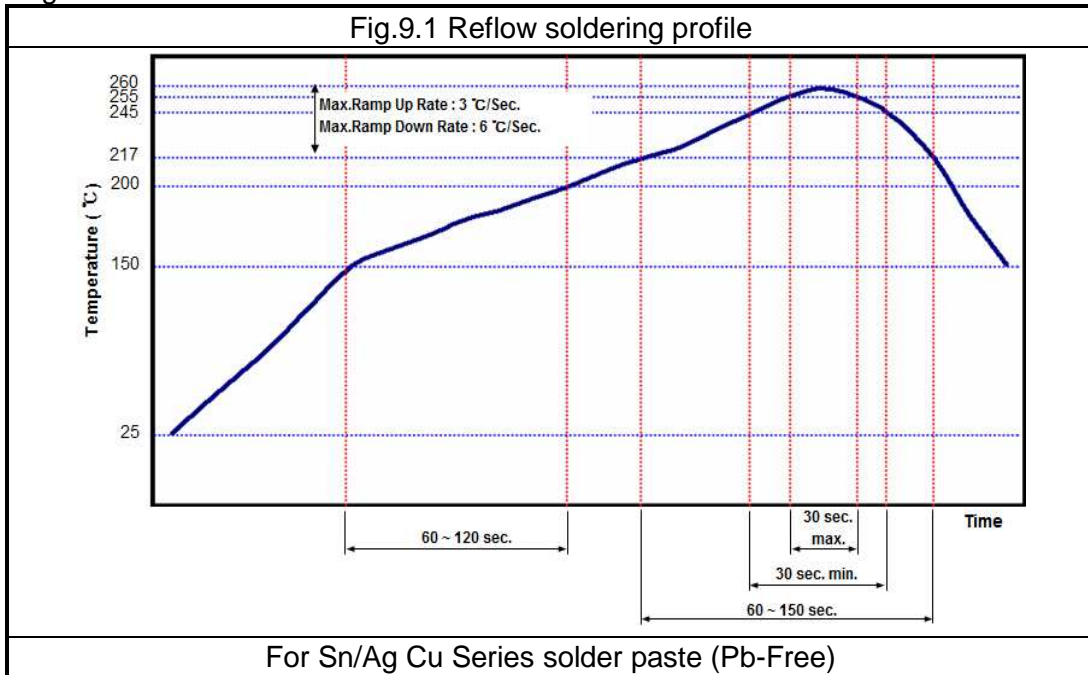
\* The tip of iron should not contact the ceramic body directly.

\* The Capacitors shall be cooled gradually at room temperature after soldering.

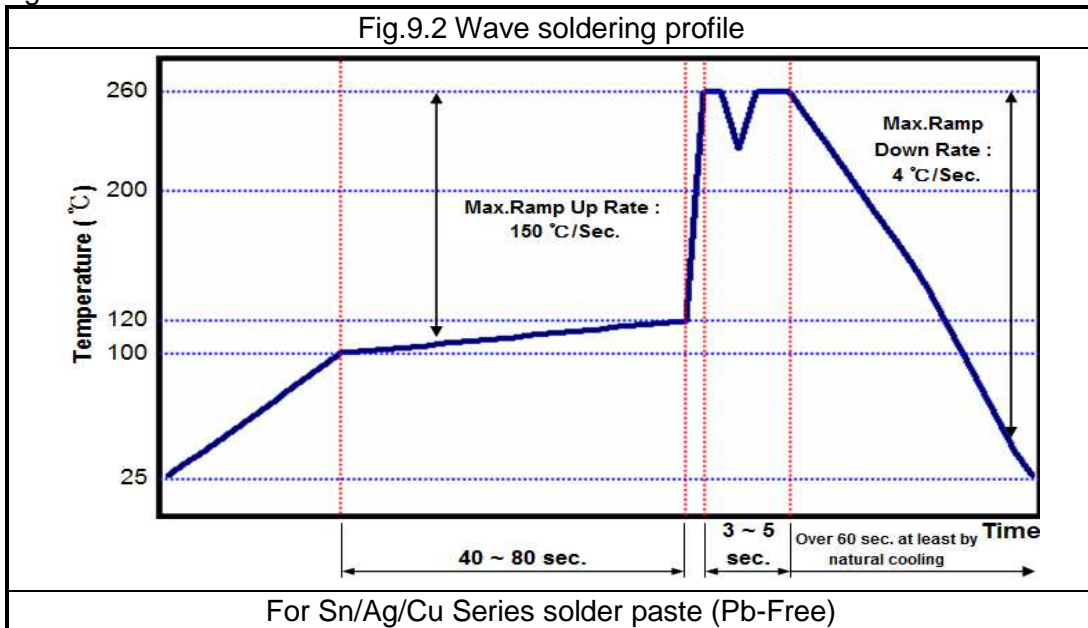
\* Forced air cooling is not allowed.

## 10. APPLICATION NOTES

b.) Reflow soldering :



c.) Wave soldering :



Soldering conditions :

Class I :

Size Inch (mm)	Temper. Cher.	Capacitance	Condition	
			Wave	Reflow
≤0402(1005)	Class I - C0G	All	X	O
0603(1608)	Class I - C0G	All	O	O
0805(2012)	Class I - C0G	All	O	O
1206(3216)	Class I - C0G	All	O	O
≥1210(3225)	Class I - C0G	All	X	O

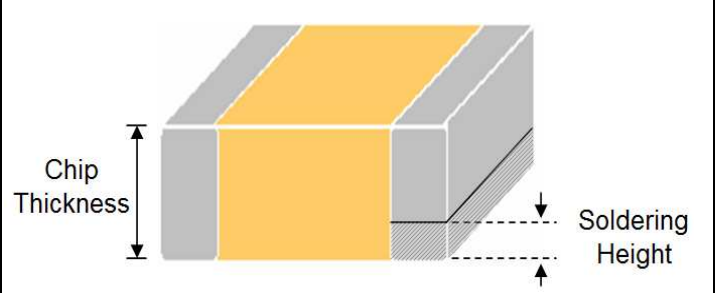
## 10. APPLICATION NOTES

Soldering conditions :

Class II :

Size Inch (mm)	Temper. Cher.	Capacitance	Condition	
			Wave	Reflow
≤0402(1005)	Class II - X7R	All	X	O
0603 (1608)	Class II - X7R	Cap. <2.2μF	O	O
		Cap. ≥2.2μF	X	O
0805 (2012)	Class II - X7R	Cap. <4.7μF	O	O
		Cap. ≥4.7μF	X	O
1206 (3216)	Class II - X7R	Cap. <4.7μF	O	O
		Cap. ≥4.7μF	X	O
≥1210 (3225)	Class II - X7R	All	X	O

Soldering height :

<p>The solder climbing minimum height is suggesting to 25% of chip thickness or 500um whichever is less. (Reference from IPC-610E)</p>	 <p>The diagram illustrates a cross-section of a chip (yellow) on a substrate (grey). A vertical double-headed arrow on the left indicates the 'Chip Thickness'. A horizontal double-headed arrow on the right indicates the 'Soldering Height', which is the height of the solder joint between the chip and the substrate.</p>
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### COOLING

After soldering, cool the chips and the substrate gradually to room temperature. Natural cooling in air is recommended to minimize stress in the solder joint.

### CLEANING

All flux residues must be removed by using suitable electronic-grade vapor-cleaning solvents to eliminate contamination that could cause electrolytic surface corrosion. Good results can be obtained by using ultrasonic cleaning of the solvent. The choice of the proper system is depends upon many factors such as component mix, flux, and solder paste and assembly method. The ability of the cleaning system to remove flux residues and contamination from under the chips is very important.